IGBT - Inverter Welding

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for welding applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

Features

- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- These are Pb–Free Devices

Typical Applications

• Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	I _C	50 25	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	100	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I _F	50 25	A
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	100	A
Gate-emitter voltage Transient gate-emitter voltage ($T_{pulse} = 5 \ \mu s, \ D < 0.10$)	V_{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	385 192	W
Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 500 V, $T_J \le 150^{\circ}C$	T _{SC}	10	μs
Operating junction temperature range	TJ	–55 to +175	°C
Storage temperature range	T _{stg}	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

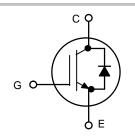
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

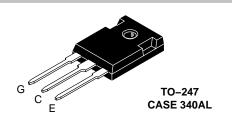


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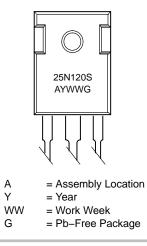
www.onsemi.com

25 A, 1200 V V_{CEsat} = 2.0 V E_{off} = 0.60 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB25N120SWG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	R_{\thetaJC}	0.39	°C/W
Thermal resistance junction-to-case, for Diode	R_{\thetaJC}	0.63	°C/W
Thermal resistance junction-to-ambient	R_{\thetaJA}	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC			-		-	
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 V, I_{C} = 500 \mu A$	V _{(BR)CES}	1200	_	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 25 A V _{GE} = 15 V, I _C = 25 A, T _J = 175°C	V _{CEsat}	_ _	2.00 2.40	2.40	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1200 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 175^{\circ}C$	I _{CES}	- -		0.4 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$, $V_{CE} = 0 \text{ V}$	I _{GES}	-	-	200	nA

Input capacitance		Cies	-	4420	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	151	-	
Reverse transfer capacitance		C _{res}	-	81	-	
Gate charge total		Qg	-	178	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 25 A, V _{GE} = 15 V	Q _{ge}	-	39	-	
Gate to collector charge		Q _{gc}	-	83	_	

SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

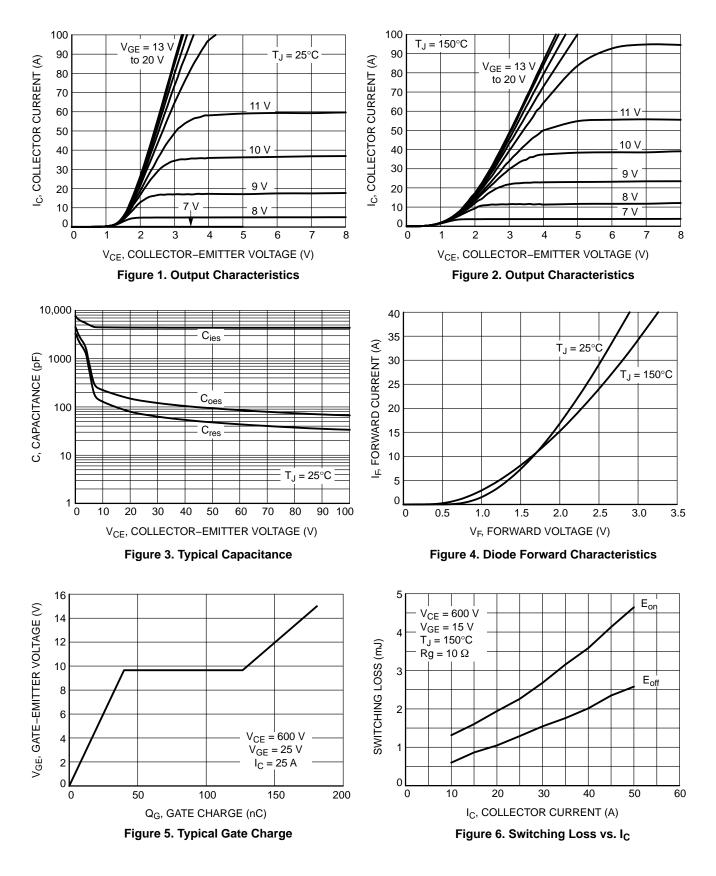
Turn-on delay time		t _{d(on)}	-	87	-	ns
Rise time		t _r	-	74	-	
Turn-off delay time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V, I}_{C} = 25 \text{ A}$	t _{d(off)}	-	179	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ $R_{a} = 10 \Omega$	t _f	-	136	-	
Turn-on switching loss	$R_g = 10 \Omega$ V _{GE} = 0 V/ 15V	Eon	-	1.95	-	mJ
Turn-off switching loss		E _{off}	-	0.60	-	
Total switching loss		E _{ts}	-	2.55	-	
Turn-on delay time		t _{d(on)}	-	84	-	ns
Rise time		t _r	-	94	-	
Turn-off delay time	T _J = 150°C V _{CC} = 600 V, I _C = 25 A	t _{d(off)}	-	185	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ $R_{a} = 10 \Omega$	t _f	-	245	-	
Turn-on switching loss	$R_g = 10 \Omega$ V _{GE} = 0 V/ 15V	E _{on}	-	2.39	-	mJ
Turn-off switching loss		E _{off}	-	1.26	-	1
Total switching loss		E _{ts}	-	3.65	-	

DIODE CHARACTERISTIC

Forward voltage	$V_{GE} = 0 V$, $I_F = 25 A$ $V_{GE} = 0 V$, $I_F = 50 A$, $T_J = 175^{\circ}C$	V _F	-	2.10 2.30	2.60 -	V
Reverse recovery time	$T_J = 25^{\circ}C$	t _{rr}	-	154	-	ns
Reverse recovery charge	I _F = 25 A, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}	-	1.3	-	μC
Reverse recovery current		I _{rrm}	-	15	-	A

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

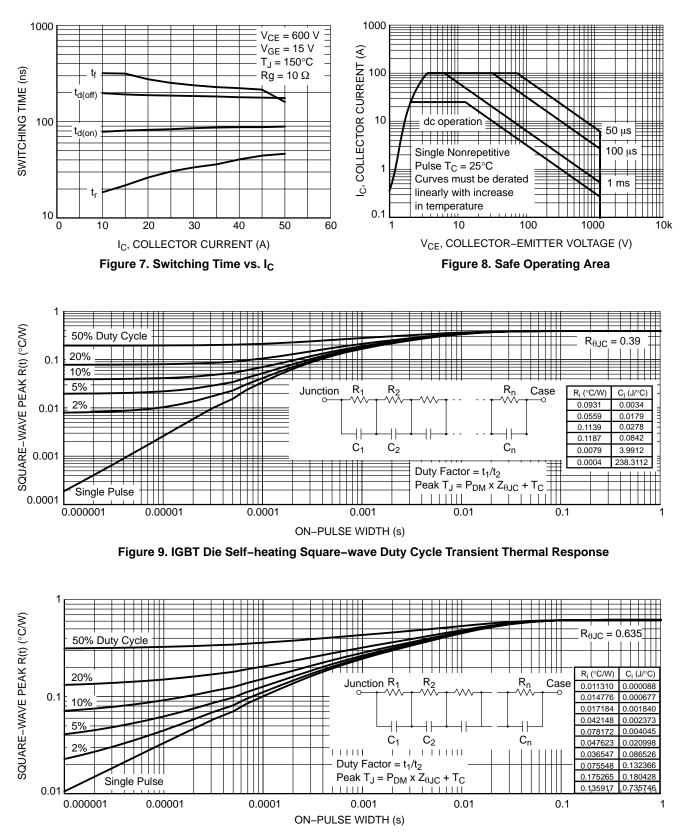
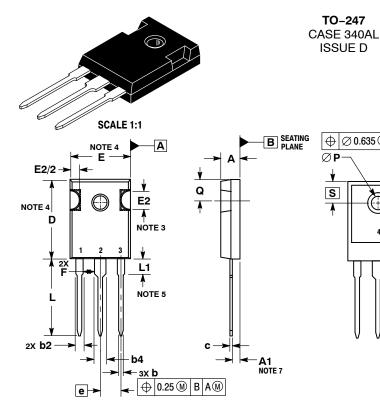


Figure 10. Diode Die Self-heating Square-wave Duty Cycle Transient Thermal Response

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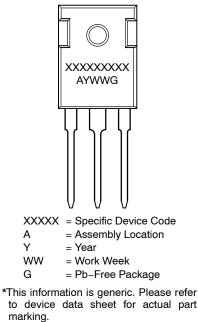
DATE 17 MAR 2017

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. SLOT REQUIRED, NOTCH MAY BE ROUNDED. 1
- 2. 3.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY 5.
- L1. 6.
- ⊘P SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.
- 7. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED

BY L1.				
	MILLIN	IETERS		
DIM	MIN	MAX		
Α	4.70	5.30		
A1	2.20	2.60		
b	1.07	1.33		
b2	1.65	2.35		
b4	2.60	3.40		
C	0.45	0.68		
D	20.80	21.34		
Е	15.50	16.25		
E2	4.32	5.49		
е	5.45	BSC		
F	2.655			
L	19.80	20.80		
L1	3.81	4.32		
Ρ	3.55	3.65		
Q	5.40	6.20		
S	6.15	BSC		

GENERIC **MARKING DIAGRAM***



Pb-Free indicator, "G" or microdot " .", may or may not be present.

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